

March 2015

FDD86110

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 50 A, 10.2 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 10.2 m Ω at V_{GS} = 10 V, I_D = 12.5 A
- Max $r_{DS(on)}$ = 16 m Ω at V_{GS} = 6 V, I_D = 9.8 A
- 100% UIL tested
- RoHS Compliant

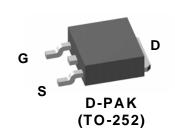


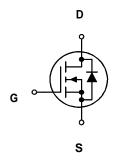
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

DC - DC Conversion





MOSFET Maximum Ratings $T_C = 25 \degree C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		50		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	12.5	Α	
	-Pulsed		(Note 4)	150		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	135	mJ	
P _D	Power Dissipation	T _C = 25 °C		127	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.1	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

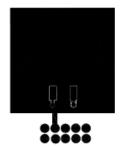
Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.98	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 40	C/VV

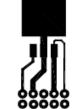
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86110	FDD86110	D-PAK(TO-252)	13 "	16 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
∆BV _{DSS}	Breakdown Voltage Temperature		100			
ΔT_{J}	Coefficient	I_D = 250 μ A, referenced to 25 °C		72		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	2.8	4	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			10		2400
ΔT_J	Temperature Coefficient $I_D = 250 \ \mu$ A, referenced to 25 °C			-10		mV/°C
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 12.5 A		8.5	10.2	
r _{DS(on)}		$V_{GS} = 6 V, I_D = 9.8 A$	11.3 1		16	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}, \text{T}_{J} = 125^{\circ}\text{C}$		15	18	
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}$		38		S
C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1MHz		1702 379	2265 505	pF pF
C _{rss}	Reverse Transfer Capacitance			17	30	pF
R _g	Gate Resistance		0.1	0.5	1.5	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			12	20	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 12.5 A,		5.4	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	35	ns
t _f	Fall Time			3.9	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$ V _{DD} = 50 V,		25	35	nC
Q _{gs}	Gate to Source Charge	$V_{DD} = 50 \text{ V},$ $I_D = 12.5 \text{ A}$		7.1		nC
Q _{gd}	Gate to Drain "Miller" Charge	10 = 12.0 X		5.2		nC
Drain-Sou	arce Diode Characteristics					
V _{SD}		V _{GS} = 0 V, I _S = 12.5 A (Note 2)		0.80	1.3	V
	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.72	1.2	
t _{rr}	Reverse Recovery Time			52	83	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 12.5 A, di/dt = 100 A/μs		60	96	nC



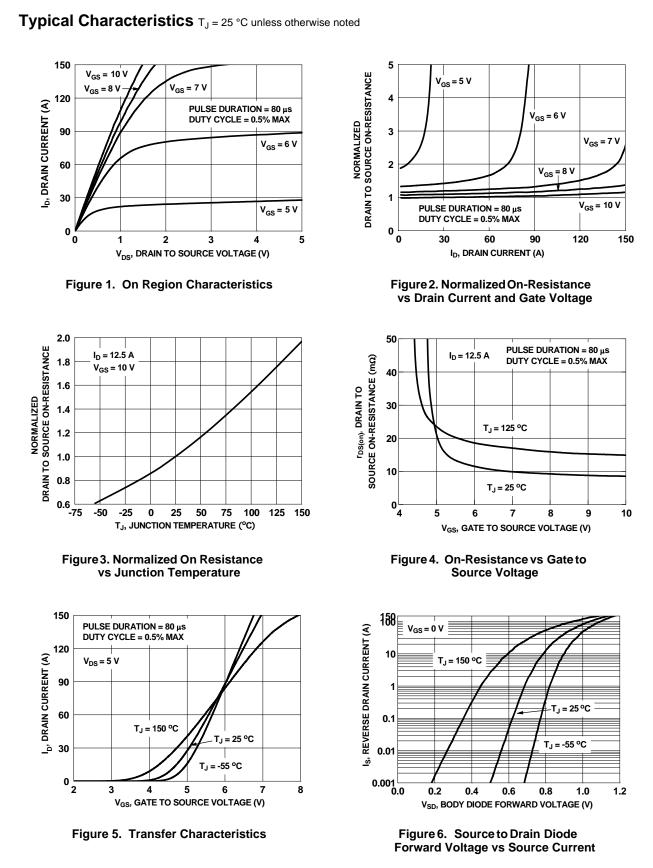
a) 40 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 96 °C/W when mounted on a minimum pad

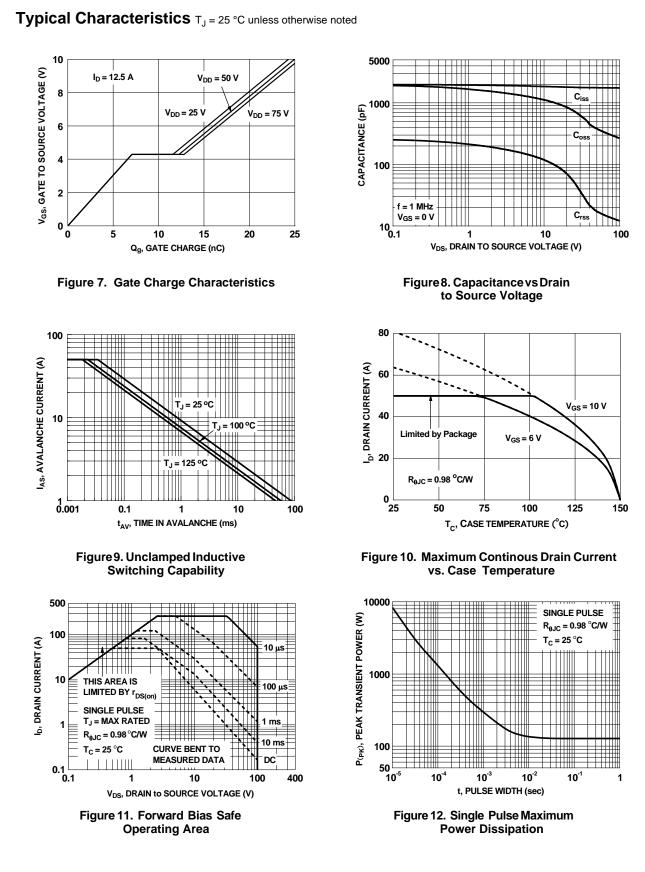
- Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.
 Starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 30 A, V_{DD} = 90 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 48 A.
 Pulsed Drain current is tested at 300 µs with 2% duty cycle. For repetitive pulses, the pulse width is limited by the maximum junction temperature.



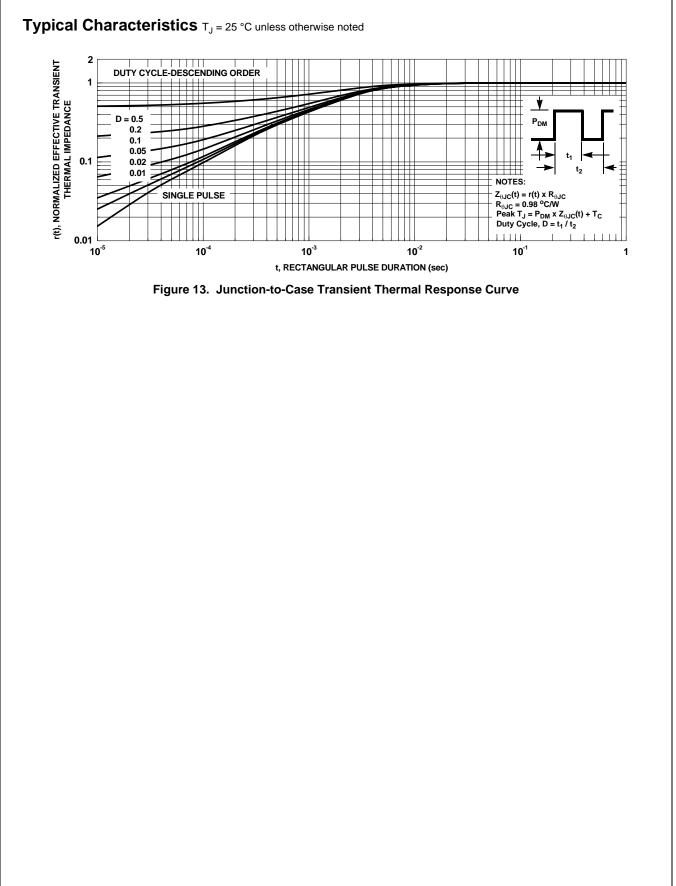


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